

TITLE

ORGANIC ELECTRONIC DEVICES WITH LOW THERMAL
RESISTANCE AND PROCESSES FOR FORMING AND USING THE
SAME

5 ABSTRACT OF THE INVENTION

 An aspect of the present invention provides an organic electronic
device includes a heat sink having a side with a roughened surface and/or
a black surface and a process for forming devices having such heat sinks
including forming a patterned electrically conductive layer includes an
10 electrically conductive member. The process includes selectively forming
spaced-apart members. The heat sink includes the spaced-apart
members, which are spaced apart from each other and thermally coupled
to the electrically conductive member.

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